

APPROVAL SHEET

MODEL NO.: mSMD075-33V	
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CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP:

DATE

MANUFACTURE	R:
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Submitted by: Approved by: DATE: Chung Cheng YC Lin 17-Jul-12

SEA & LAND ELECTRONIC CORP.



mSMD075-33V

Features

Surface Mount Devices

for automated assembly

Lead free device Size 4.5*3.2 mm/0.18*0.12 inch Surface Mount packaging

power supply, up to 60V and a load to be

Applications

protected, including:

Computer mother board, Modem. USB hub

Almost anywhere there is a low voltage

PDAs & Charger, Analog & digital line card

Digital cameras, Disk drivers, CD-ROMs,

Alpha-Top (Sea & Land Alliance)

Performance Specification

						Maxii	mum	Resis	stance		
Model	V _{max}	max	hold	I _{trip}	Pd	Time T	o Trip			Agency A	Approval
inicaci			@25°C	@25°C	Тур.	Current	Time	Ri _{min}	R1 _{max}	UL	τυν
	(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)	02	
mSMD075-33V	33.0	100	0.75	1.50	0.8	8.0	0.20	0.090	0.450		
Ihold = Hold Current.	Maximum cur	rent device w	ill not trip in 2	5°C still air.							
Itrip = Trip Current. N	1inimum curre	ent at which th	e device will a	always trip in 2	25°C still air.						
Vmax = Maximum ope	Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).										
Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).											
Pd = Power dissipat	Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.										
Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.											
R1 _{max} = Maximum dev	R1 _{max} = Maximum device resistance is measured one hour post reflow.										
CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.											

Environmental Specifications

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202, Method 215	No change
Vibration	MIL-STD-202, Method 201	No change
Ambient operating conditions : - 40 °C to +85 °C		
Maximum surface temperature of the device in the trippe	ed state is 125 °C	

Agency Approvals :

UL pending

Regulation/Standard:



Ihold Versus Temperature

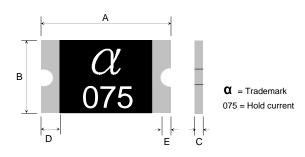
Model	Model Maximum ambient operating temperature (T _{mao}) vs. hold current (I _{hold})								
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
mSMD075-3	3V 1.10	0.99	0.87	0.75	0.63	0.57	0.49	0.45	0.35

mSMD075-<u>3</u>3V

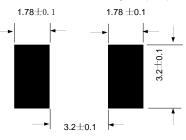
Alpha-Top (Sea & Land Alliance)

Construction And Dir	nension (Unit:n	nm)						
Model	ļ	4		3	(C D		E
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
mSMD075-33V	4.37	4.73	3.07	3.41	0.40	0.90	0.30	0.25

Dimensions & Marking



Recommended Pad Layout (mm)



Termination Pad Characteristics

Terminal pad materials :

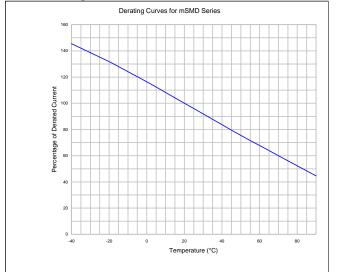
Tin-plated Nickel-Copper Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

Terminal pad solderability :

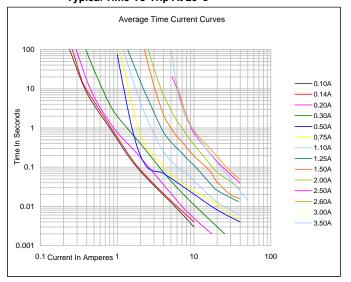
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

Thermal Derating Curve



Typical Time-To-Trip At 25°C



WARNING:

 Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.

Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.

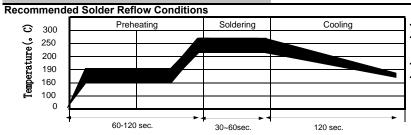
· Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.

- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.

Requests that customers comply with our recommended solder and lavouts and recommended reflow profile. Improver hoard lavouts or reflow profile could negatively impact solderabilit

mSMD075-33V

Alpha-Top (Sea & Land Alliance)

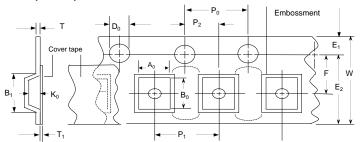


- Recommended reflow methods : IR, vapor phase oven, hot air oven. Devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness is 0.25 mm (0.010 inch). Devices can be cleaned using standard method and solvents.
- Note : If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

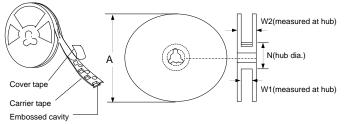
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	12 ± 0.3
P0	4.0 ± 0.10
<u>P1</u>	8.0 ± 0.10
P2	2.0 ± 0.05
A0	3.5 ± 0.23
B0	5.1 ± 0.15
B1max.	5.9
D0	1.5 + 0.1, -0
F	5.5 ± 0.05
<u>E1</u>	1.75 ± 0.10
E2min.	10.25
Tmax.	0.6
T1max.	0.1
<u>K0</u>	0.9 ± 0.15
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W1	12.4 + 2.0, -0.0
W2max.	18.4

EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

- Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance
- if storage conditions are exceeded.

Order Information

Order Information			Packaging
mSMD	'075	-33V	Tape & Reel Quantity
Product name	Hold	Max	
Size 4532mm/1812 inch	Current	Voltage	1,500 pcs/reel
SMD : surface mount device	0.75A	-	
	0.15A		

Tape & reel packaging per EIA481-1

Labeling Information

